

FS30VSJ-3

High-Speed Switching Use Nch Power MOS FET

REJ03G1416-0200

(Previous: MEJ02G0081-0101) Rev.2.00

Aug 07, 2006

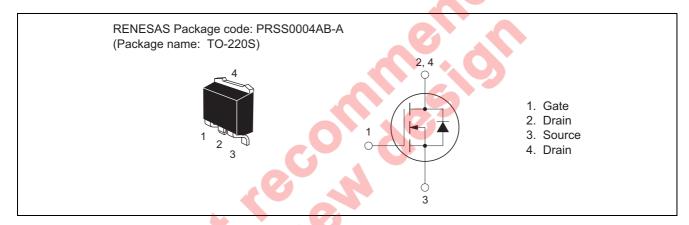
Features

Drive voltage: 4 V
 V_{DSS}: 150 V
 r_{DS(ON) (max)}: 86 mΩ

• I_D: 30 A

• Integrated Fast Recovery Diode (TYP.): 100 ns

Outline



Applications

Motor control, Lamp control, Solenoid control, DC-DC converters, etc.

Maximum Ratings

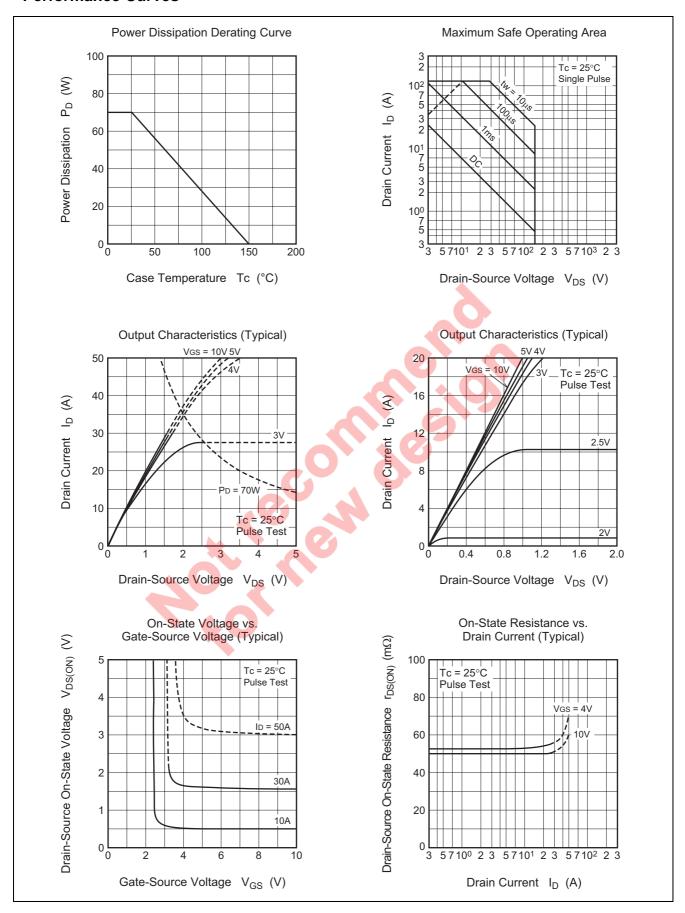
 $(Tc = 25^{\circ}C)$

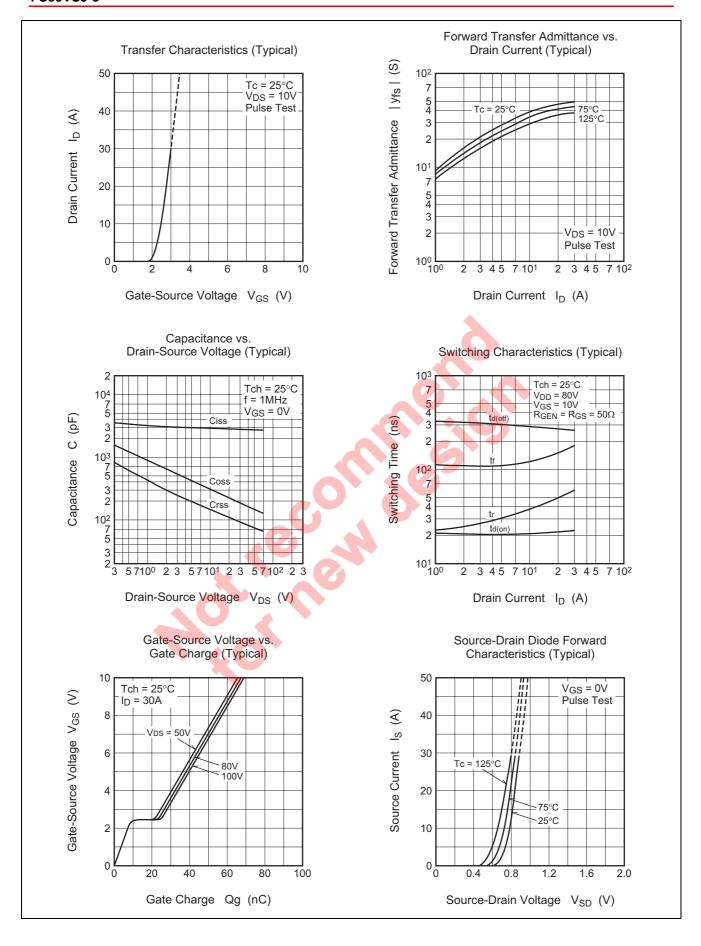
Parameter	Symbol	Ratings	Unit	Conditions
Drain-source voltage	V _{DSS}	150	V	V _{GS} = 0 V
Gate-source voltage	V_{GSS}	±20	V	$V_{DS} = 0 V$
Drain current	I _D	30	Α	
Drain current (Pulsed)	I _{DM}	120	Α	
Avalanche drain current (Pulsed)	I _{DA}	30	Α	L = 100 μH
Source current	Is	30	Α	
Source current (Pulsed)	I _{SM}	120	Α	
Maximum power dissipation	P _D	70	W	
Channel temperature	Tch	- 55 to +150	°C	
Storage temperature	Tstg	- 55 to +150	°C	
Mass	-	1.2	g	Typical value

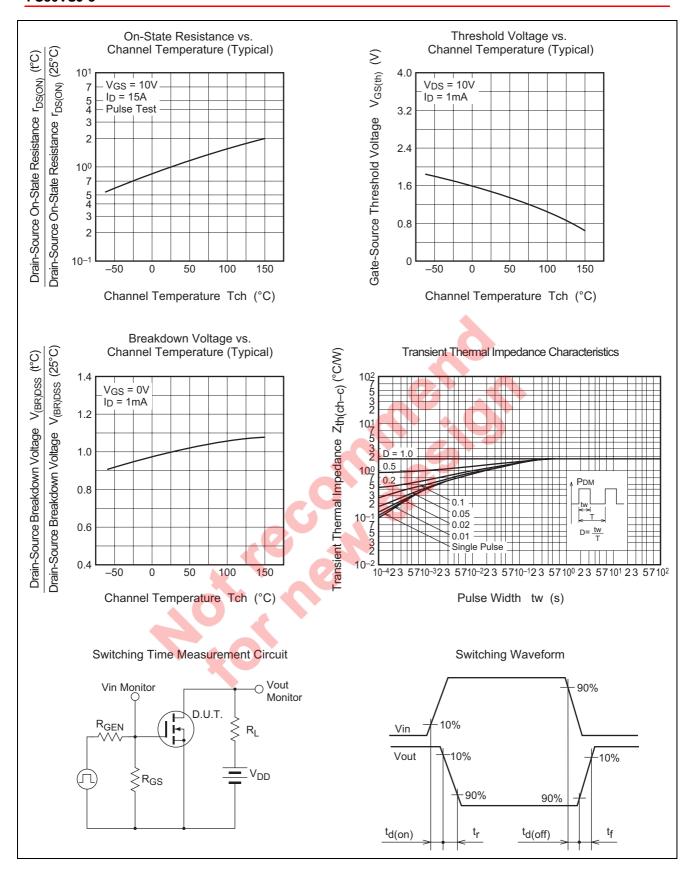
Electrical Characteristics

 $(Tch = 25^{\circ}C)$

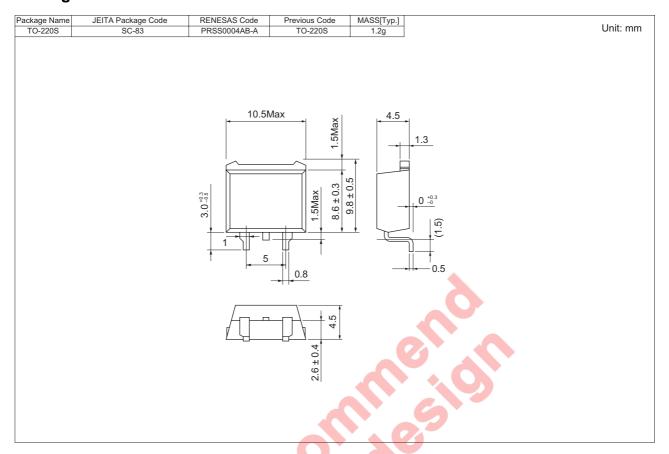
Performance Curves







Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Surface-mounted type	Taping	1000	Type name – T +Direction (1 or 2) +1	FS30VSJ-3-T11
Surface-mounted type	Plastic Magazine (Tube)	50	Type name	FS30VSJ-3
Straight type	Plastic Magazine (Tube)	50	Type name +A1	FS30VSJ-3-A1

Note: Please confirm the specification about the shipping in detail.

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